Fabrication of FETs Based on La-BaSnO, Perovskite Oxide

CNF Project Number: 2543-17 Principal Investigator: Darrell Schlom User: Jisung Park

Affiliation: Department of Material Science and Engineering, Cornell University, Ithaca, NY 14853, USA Primary Source of Research Funding: Air Force Office of Scientific Research – DOD Contact: schlom@cornell.edu, gp359@cornell.edu Primary CNF Tools Used: PVD75 sputter deposition, AJA ion mill, Oxford ALD FlexAL

Abstract:

A field effect transistor based on La-BaSnO₃ (BLSO) has been made. The BLSO is a perovskite oxide material with high mobility and oxygen stability. The BLSO film was grown by molecular beam epitaxy. It has been etched with the AJA ion mill to make a channel layer, and ITO is deposited on the channel layer as the source and drain contact layer by PVD75 sputter deposition. ALD-grown HfO₂ film was deposited on it as a dielectric oxide by Oxford ALD FlexAL. ITO is deposited again by the same tool as a gate electrode. The schematic is shown in Figure 1. The device shows good characteristic curve in terms of I_{ds} - V_{ds} and I_{ds} - V_{gs} . The on-off ratio is over 6 × 10⁶ and mobility is over 20 cm²/V·s. The characteristic curve of the device is shown in Figure 3.



*Figure 1: Schematic of the filed effect transistor based on La-BaSnO*₃*.*

Summary of Research:

Field effect transistor based on La-BaSnO₃ (BLSO) has been fabricated and nice characteristic curves with high on-off ratio over 6×10^6 and mobility over $20 \text{ cm}^2/\text{V} \cdot \text{s}$ has been shown.

References:

- [1] H. J. Kim, U. Kim, H. M. Kim, T. H. Kim, H. S. Mun, B.-G. Jeon, K. T. Hong, W.-J. Lee, C. Ju, K. H. Kim, and K. Char, Appl. Phys. Express 5, 061102 (2012).
- [2] C. Park, U. Kim, C. J. Ju, J. S. Park, Y. M. Kim, and K. Char, Appl. Phys. Lett. 105, 203503 (2014).
- [3] Y. M. Kim, C. Park, U. Kim, C. Ju, and K. Char, Appl. Phys. Express 9, 011201 (2016).
- [4] U. Kim, C. Park, T. Ha, Y. M. Kim, N. Kim, C. Ju, J. Park, J. Yu, J. H. Kim, and K. Char, APL Mater. 3, 036101 (2015).



Figure 2, left: Output characteristic curve of the device. Figure 3, right: Transfer characteristic of the device.



